

# DATA SHEET



## **PCA9516** 5-channel I<sup>2</sup>C hub

Product data  
Supersedes data of 2002 Mar 01

2002 May 13

5-channel I<sup>2</sup>C hub

## PCA9516



## DESCRIPTION

The PCA9516 is a BiCMOS integrated circuit intended for application in I<sup>2</sup>C and SMBus systems.

While retaining all the operating modes and features of the I<sup>2</sup>C system, it permits extension of the I<sup>2</sup>C bus by buffering both the data (SDA) and the clock (SCL) lines, thus enabling five buses of 400 pF.

The I<sup>2</sup>C bus capacitance limit of 400 pF restricts the number of devices and bus length. Using the PCA9516 enables the system designer to divide the bus into five segments off of a hub where any segment to segment transition sees only one repeater delay.

It can also be used to run different buses at 5 V and 3.3 V or 400 kHz and 100 kHz buses where the 100 kHz bus is isolated when 400 kHz operation of the other bus is required.

## FEATURES

- 5 channel, bi-directional buffer
- I<sup>2</sup>C-bus and SMBus compatible
- Active high individual repeater enable input
- Open-drain input/outputs
- Lock-up free operation
- Supports arbitration and clock stretching across the repeater
- Accommodates standard mode and fast mode I<sup>2</sup>C devices and multiple masters
- Powered-off high impedance I<sup>2</sup>C pins
- Operating supply voltage range of 3.0 V to 3.6 V
- 5 V tolerant I<sup>2</sup>C and enable pins
- 0 to 400 kHz clock frequency<sup>1</sup>
- ESD protection exceeds 2000 V HBM per JESD22-A114, 200 V MM per JESD22-A115, and 1000 V CDM per JESD22-C101.
- Latch-up testing is done to JEDEC Standard JESD78 which exceeds 100 mA.
- Package offerings: SO and TSSOP

## ORDERING INFORMATION

DESCRIPTION	TEMPERATURE RANGE	ORDER CODE	DRAWING NUMBER
16-pin plastic SO (narrow)	-40 to +85 °C	PCA9516D	SOT109-1
16-pin plastic TSSOP	-40 to +85 °C	PCA9516PW	SOT403-1

Standard packing quantities and other packaging data is available at [www.philipslogic.com/packaging](http://www.philipslogic.com/packaging).

## PIN CONFIGURATION

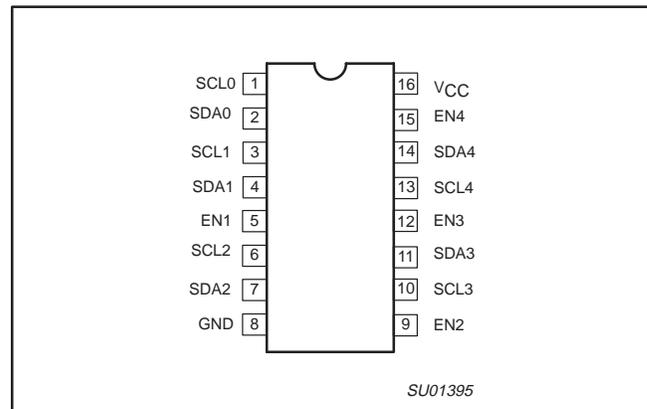


Figure 1. Pin configuration

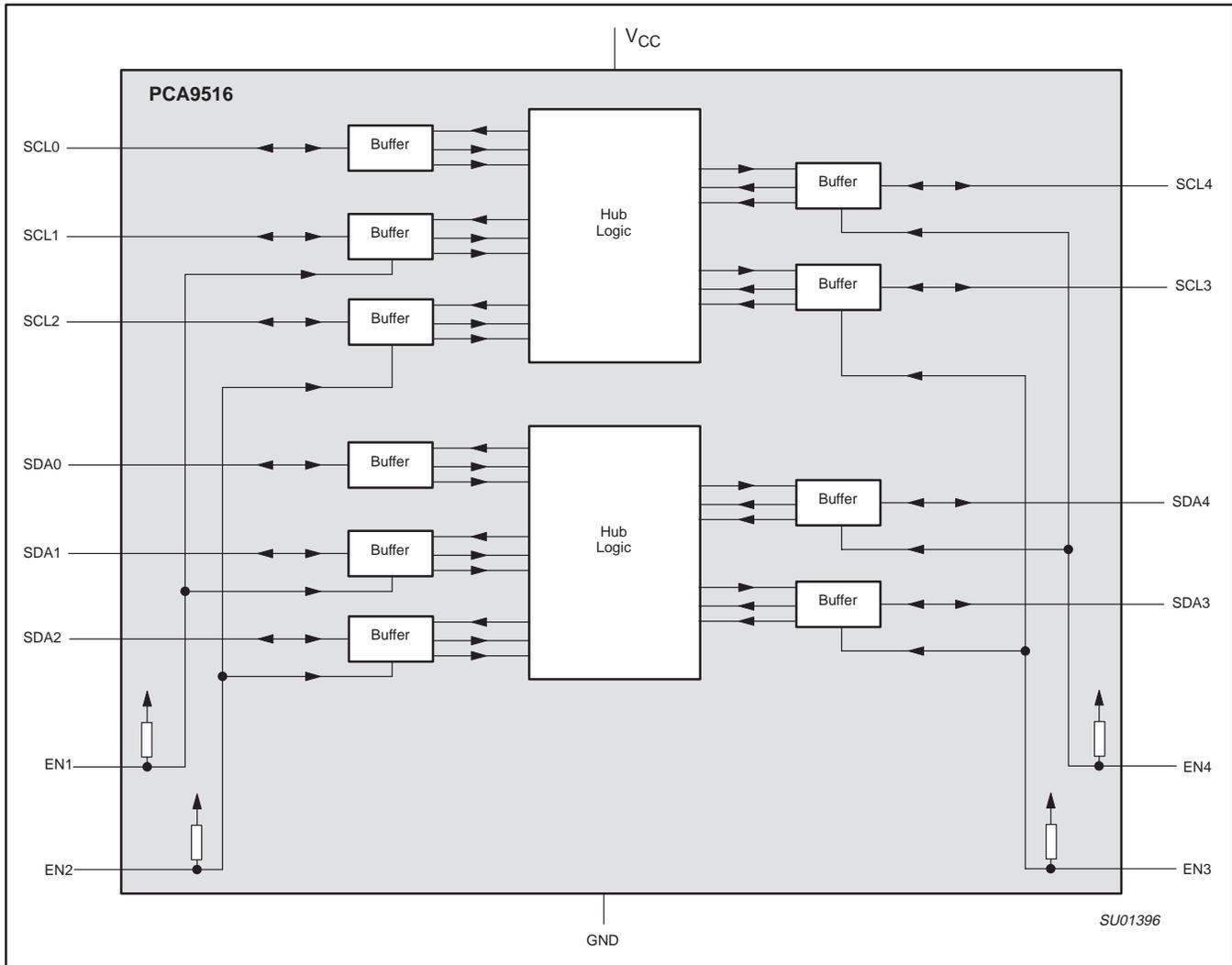
## PIN DESCRIPTION

PIN	SYMBOL	FUNCTION
1	SCL0	Serial clock bus 0
2	SDA0	Serial data bus 0
3	SCL1	Serial clock bus 1
4	SDA1	Serial data bus 1
5	EN1	Active High Bus 1 enable Input
6	SCL2	Serial clock bus 2
7	SDA2	Serial data bus 2
8	GND	Supply ground
9	EN2	Active High Bus 2 enable Input
10	SCL3	Serial clock bus 3
11	SDA3	Serial data bus 3
12	EN3	Active High Bus 3 enable Input
13	SCL4	Serial clock bus 4
14	SDA4	Serial data bus 4
15	EN4	Active High Bus 4 enable Input
16	V <sub>CC</sub>	Supply power

1. The maximum system operating frequency may be less than 400 KHz because of the delays added by the repeater.

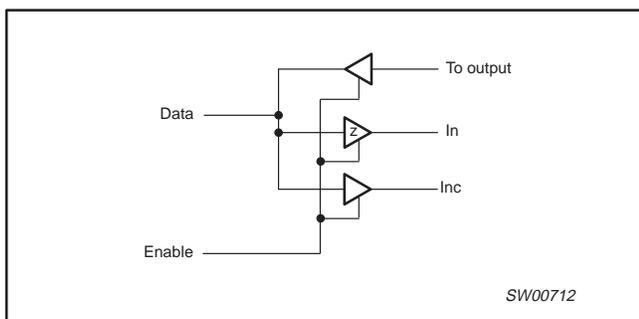
# 5-channel I<sup>2</sup>C hub

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**Figure 2. Block Diagram: PCA9516**

A more detailed view of Figure 2 buffer is shown in Figure 3.



**Figure 3.**

The output pull-down of each internal buffer is set for approximately 0.5 V, while the input threshold of each internal buffer is set about 0.07 V lower, when the output is internally driven low. This prevents a lock-up condition from occurring.

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## FUNCTIONAL DESCRIPTION

The PCA9516 BiCMOS integrated circuit is a five way hub repeater, which enables I<sup>2</sup>C and similar bus systems to be expanded with only one repeater delay and no functional degradation of system performance.

The PCA9516 BiCMOS integrated circuit contains five bi-directional, open drain buffers specifically designed to support the standard low-level-contention arbitration of the I<sup>2</sup>C-bus. Except during arbitration or clock stretching, the PCA9516 acts like five pairs of non-inverting, open drain buffers, one for SDA and one for SCL.

### Enable

The enable pins EN1 through EN4 are active high and have internal pull-up resistors. Each enable pin ENn controls its associated SDAn and SCLn ports. When low the ENn pin blocks the inputs from SDAn and SCLn as well as disabling the output drivers on the SDAn and SCLn pins. The enable pins should only change state when both the global bus and the local port are in an idle state to prevent system failures.

The active high enable pins allow the use of open drain drivers which can be wire-ORed to create a distributed enable where either centralized control signal (master) or spoke signal (submaster) can enable the channel when it is idle.

### I<sup>2</sup>C Systems

As with the standard I<sup>2</sup>C system, pull-up resistors are required to provide the logic HIGH levels on the Buffered bus. (Standard open-collector configuration of the I<sup>2</sup>C-bus). The size of these pull-up resistors depends on the system, but each side of the repeater must have a pull-up resistor. This part designed to work with standard mode and fast mode I<sup>2</sup>C devices in addition to SMBus devices. Standard mode I<sup>2</sup>C devices only specify 3 mA output drive, this limits the termination current to 3 mA in a generic I<sup>2</sup>C system where standard mode devices and multiple masters are possible. Under certain conditions higher termination currents can be used. Please see Application Note AN255 "I<sup>2</sup>C & SMBus Repeaters, Hubs and Expanders" for additional information on sizing resistors and precautions when using more than one PCA9515/PCA9516 in a system or using the PCA9515/16 in conjunction with the P82B96.

## APPLICATION INFORMATION

A typical application is shown in Figure 4. In this example, the system master is running on a 3.3 V I<sup>2</sup>C-bus while the slave is connected to a 5 V bus. All buses run at 100 kHz unless slave 3 and 4 are isolated and then the master bus and slave 1 and 2 can run at 400 kHz.

Any segment of the hub can talk to any other segment of the hub. Bus masters and slaves can be located on all five segments with 400 pF load allowed on each segment.

The PCA9516 is 5 V tolerant so it does not require any additional circuitry to translate between the different bus voltages.

When one side of the PCA9516 is pulled low by a device on the I<sup>2</sup>C-bus, a CMOS hysteresis type input detects the falling edge and causes an internal driver on the other side to turn on, thus causing

the other side to also go low. The side driven low by the PCA9516 will typically be at V<sub>OL</sub> = 0.5 V.

In order to illustrate what would be seen in a typical application, refer to Figures 5 and 6. If the bus master in Figure 4 were to write to the slave through the PCA9516, we would see the waveform shown in Figure 5 on Bus 0. This looks like a normal I<sup>2</sup>C transmission until the falling edge of the 8th clock pulse. At that point, the master releases the data line (SDA) while the slave pulls it low through the PCA9516. Because the V<sub>OL</sub> of the PCA9516 is typically around 0.5 V, a step in the SDA will be seen. After the master has transmitted the 9th clock pulse, the slave releases the data line.

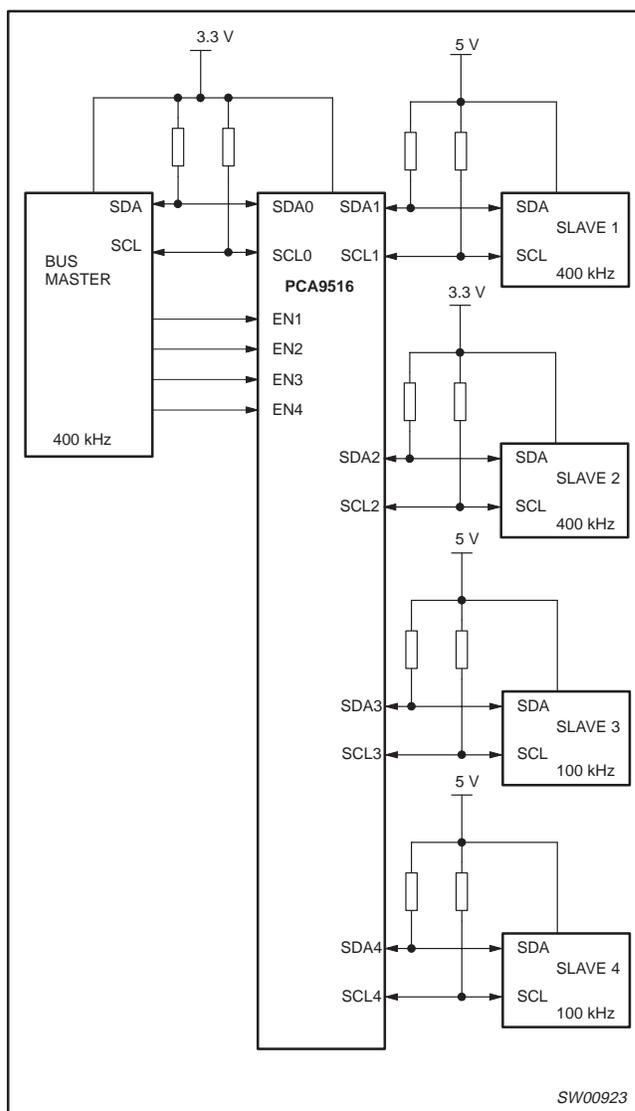


Figure 4. Typical application

5-channel I<sup>2</sup>C hub

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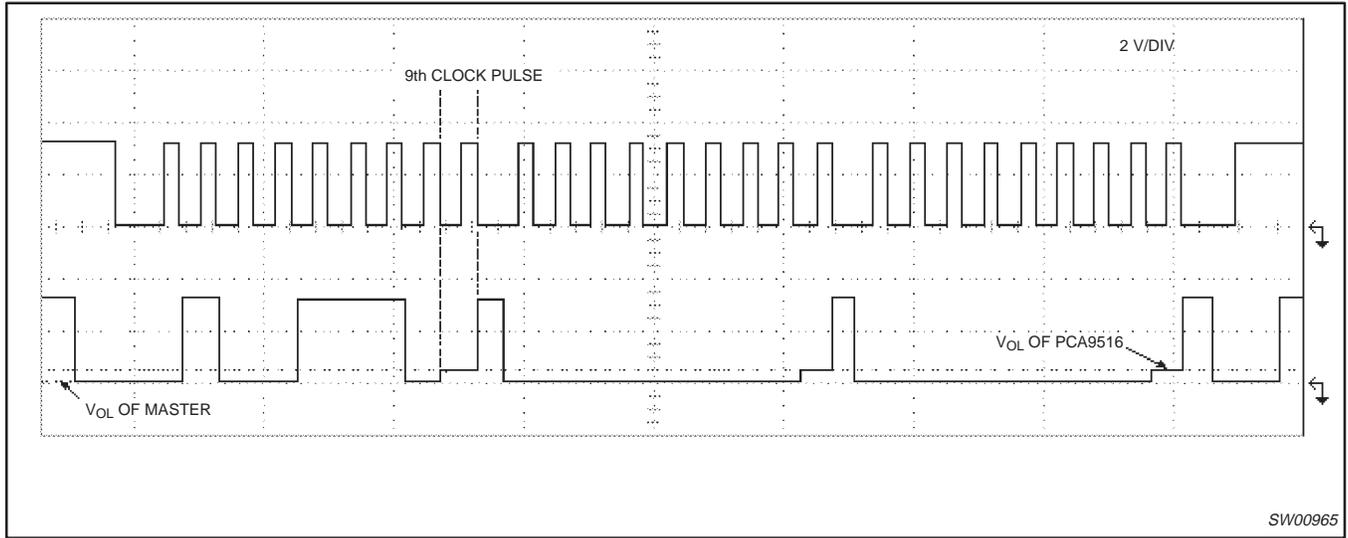


Figure 5. Bus 0 waveform

On the Bus 1 side of the PCA9516, the clock and data lines would have a positive offset from ground equal to the  $V_{OL}$  of the PCA9516. After the 8th clock pulse, the data line will be pulled to the  $V_{OL}$  of the slave device that is very close to ground in our example.

It is important to note that any arbitration or clock stretching events on Bus 1 require that the  $V_{OL}$  of the devices on Bus 1 be 70 mV below the  $V_{OL}$  of the PCA9516 (see  $V_{OL} - V_{ilc}$  in the DC Characteristics section) to be recognized by the PCA9516 and then transmitted to Bus 0.

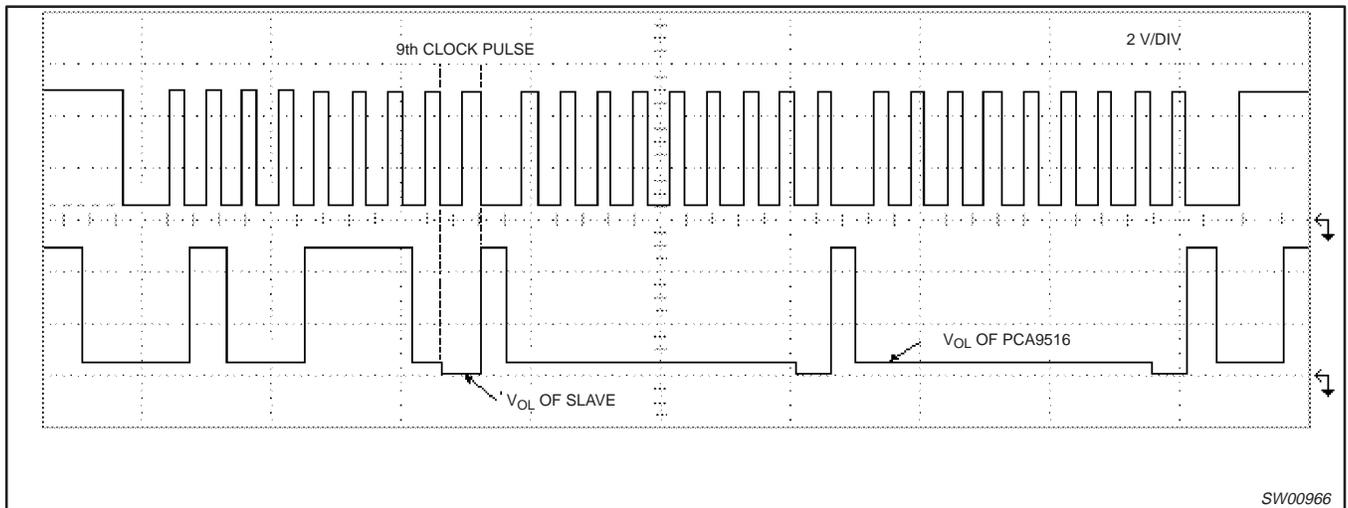


Figure 6. Bus 1 waveform

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**ABSOLUTE MAXIMUM RATINGS**

Limiting values in accordance with the Absolute Maximum System (IEC 134).  
 Voltages with respect to pin GND.

SYMBOL	PARAMETER	LIMITS		UNIT
		MIN.	MAX.	
V <sub>CC</sub> to GND	Supply voltage range V <sub>CC</sub>	-0.5	+7	V
V <sub>bus</sub>	Voltage range I <sup>2</sup> C-bus, SCL or SDA	-0.5	+7	V
I	DC current (any pin)	—	50	mA
P <sub>tot</sub>	Power dissipation	—	300	mW
T <sub>stg</sub>	Storage temperature range	-55	+125	°C
T <sub>amb</sub>	Operating ambient temperature range	-40	+85	°C

**DC ELECTRICAL CHARACTERISTICS**

V<sub>DD</sub> = 3.0 to 3.6 V; GND = 0 V; T<sub>amb</sub> = -40 to +85 °C; unless otherwise specified.

SYMBOL	PARAMETER	TEST CONDITIONS	LIMITS			UNIT
			MIN.	TYP.	MAX.	
<b>Supplies</b>						
V <sub>CC</sub>	DC supply voltage		3.0	3.3	3.6	V
I <sub>CCH</sub>	Quiescent supply current, both channels HIGH	V <sub>CC</sub> = 3.6 V; SDAn = SCLn = V <sub>CC</sub>	—	7	10	mA
I <sub>CCL</sub>	Quiescent supply current, both channels LOW	V <sub>CC</sub> = 3.6 V; one SDA and one SCL = GND, other SDA and SCL open	—	6.8	10	mA
I <sub>CCLc</sub>	Quiescent supply current in contention	V <sub>CC</sub> = 3.6 V; SDAn = SCLn = GND	—	7	10	mA
<b>Input SCL; input/output SDA</b>						
V <sub>IH</sub>	High-level input voltage		0.7 V <sub>CC</sub>	—	5.5	V
V <sub>IL</sub>	Low-level input voltage (Note 1)		-0.5	—	0.3 V <sub>CC</sub>	V
V <sub>ILc</sub>	Low-level input voltage contention (Note 1)		-0.5	—	0.4	V
V <sub>IK</sub>	Input clamp voltage	I <sub>I</sub> = -18 mA	—	—	-1.2	V
I <sub>I</sub>	Input leakage current	V <sub>I</sub> = 3.6 V	—	—	±1	μA
I <sub>IL</sub>	Input current LOW, SDA, SCL	V <sub>I</sub> = 0.2 V, SDA, SCL	—	—	5	μA
V <sub>OL</sub>	Low level output	I <sub>OL</sub> = 0 or 6 mA	0.47	.52	0.6	V
V <sub>OL</sub> -V <sub>ILc</sub>	Low level input voltage below output low level voltage	Guaranteed by design	—	—	70	mV
I <sub>OH</sub>	Output high level leakage current	V <sub>O</sub> = 3.6 V	—	—	10	μA
C <sub>I</sub>	Input capacitance	V <sub>I</sub> = 3 V or 0 V	—	6	10	pF
<b>Enable 1-4</b>						
V <sub>IL</sub>	LOW level input voltage		-0.5	—	0.8	V
V <sub>IH</sub>	HIGH level input voltage		2.0	—	5.5	V
I <sub>IL</sub>	Input current LOW, EN1-EN4	V <sub>I</sub> = 0.2 V, EN1-EN4	—	10	30	μA
I <sub>LI</sub>	Input leakage current		-1	—	1	μA
C <sub>I</sub>	Input capacitance	V <sub>I</sub> = 3.0 V or 0 V	—	6	7	pF

**NOTE:**

- V<sub>IL</sub> specification is for enable input and the first low level seen by the SDAx/SCLx lines. V<sub>ILc</sub> is for the second and subsequent low levels seen by the SDAx/SCLx lines.

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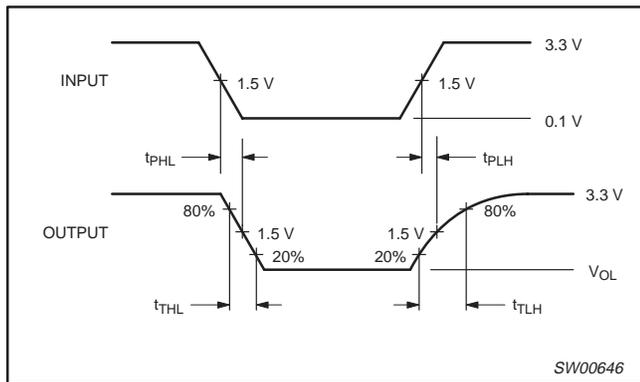
## AC ELECTRICAL CHARACTERISTICS

SYMBOL	PARAMETER	TEST CONDITIONS	LIMITS			UNIT
			MIN.	TYP.	MAX.	
t <sub>PHL</sub>	Propagation delay	Waveform 1	57	115	170	ns
t <sub>PLH</sub>	Propagation delay	Waveform 1	33	55	78	ns
t <sub>THL</sub>	Transition time	Waveform 1		67		ns
t <sub>TLH</sub>	Transition time	Waveform 1; Note 1		135		ns
t <sub>SET</sub>	Enable to Start condition		100			ns
t <sub>HOLD</sub>	Enable after Stop condition		100			ns

**NOTE:**

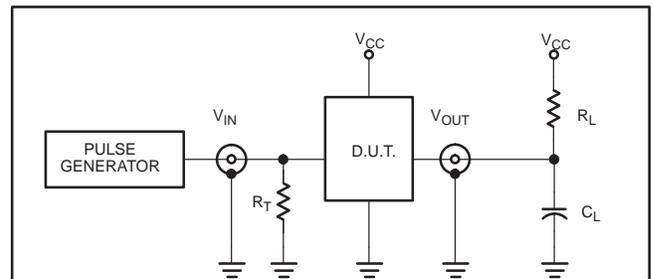
1. The t<sub>TLH</sub> transition time is guaranteed with loads of 1.35 kΩ pull-up resistance and 7 pF load capacitance, plus an additional 50 pF load capacitance. Different load resistance and capacitance will alter the RC time constant, thereby changing the propagation delay and transition times.

### AC WAVEFORMS



**Waveform 1.**

### TEST CIRCUIT



Test Circuit for Open Drain Outputs

**DEFINITIONS**

- R<sub>L</sub> = Load resistor; 1.35 kΩ
- C<sub>L</sub> = Load capacitance includes jig and probe capacitance; 7 pF
- R<sub>T</sub> = Termination resistance should be equal to Z<sub>OUT</sub> of pulse generators.

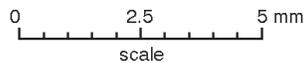
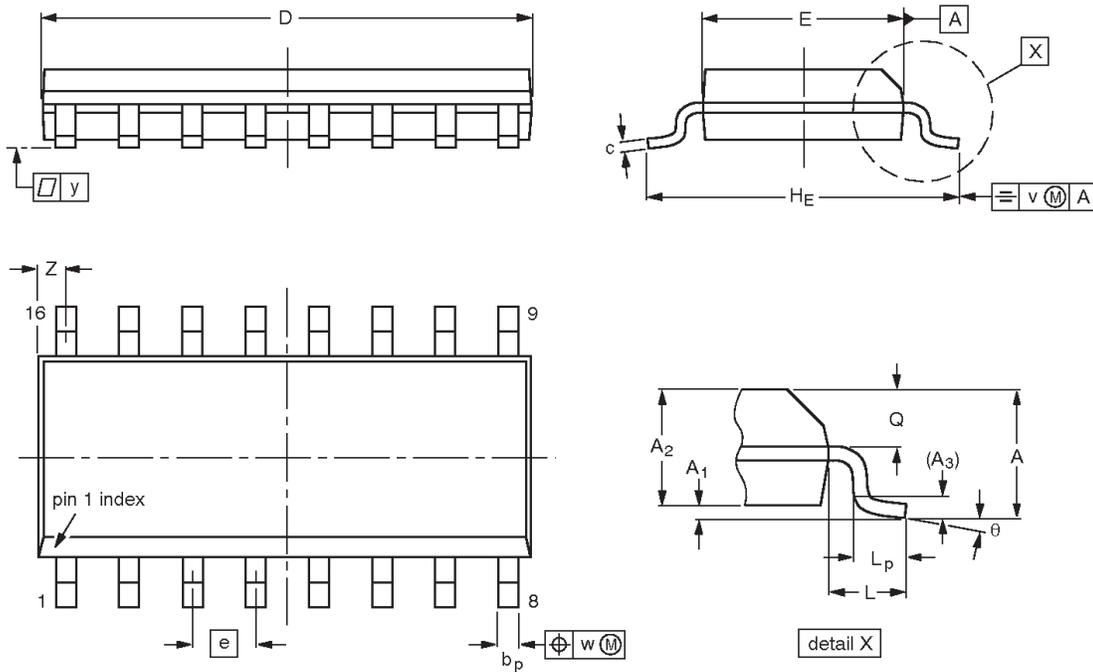
SW00792

# 5-channel I<sup>2</sup>C hub

# PCA9516

**SO16:** plastic small outline package; 16 leads; body width 3.9 mm

**SOT109-1**



**DIMENSIONS (inch dimensions are derived from the original mm dimensions)**

UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	b <sub>p</sub>	c	D <sup>(1)</sup>	E <sup>(1)</sup>	e	H <sub>E</sub>	L	L <sub>p</sub>	Q	v	w	y	Z <sup>(1)</sup>	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	10.0 9.8	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8° 0°
inches	0.069	0.010 0.004	0.057 0.049	0.01	0.019 0.014	0.0100 0.0075	0.39 0.38	0.16 0.15	0.050	0.244 0.228	0.041	0.039 0.016	0.028 0.020	0.01	0.01	0.004	0.028 0.012	

**Note**

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

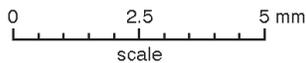
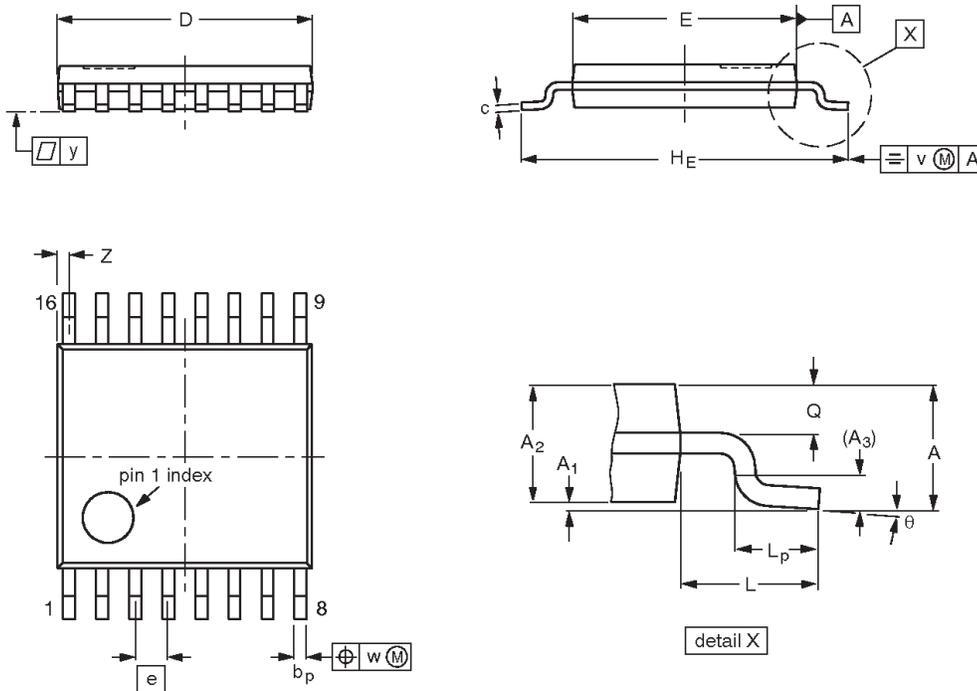
OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT109-1	076E07	MS-012				97-05-22- 99-12-27

# 5-channel I<sup>2</sup>C hub

# PCA9516

**TSSOP16:** plastic thin shrink small outline package; 16 leads; body width 4.4 mm

**SOT403-1**



**DIMENSIONS (mm are the original dimensions)**

UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	b <sub>p</sub>	c	D <sup>(1)</sup>	E <sup>(2)</sup>	e	H <sub>E</sub>	L	L <sub>p</sub>	Q	v	w	y	Z <sup>(1)</sup>	θ
mm	1.10	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	5.1 4.9	4.5 4.3	0.65	6.6 6.2	1.0	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.40 0.06	8° 0°

**Notes**

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT403-1		MO-153				95-04-04 99-12-27

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Purchase of Philips I<sup>2</sup>C components conveys a license under the Philips' I<sup>2</sup>C patent to use the components in the I<sup>2</sup>C system provided the system conforms to the I<sup>2</sup>C specifications defined by Philips. This specification can be ordered using the code 9398 393 40011.

## Data sheet status

Data sheet status <sup>[1]</sup>	Product status <sup>[2]</sup>	Definitions
Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
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[1] Please consult the most recently issued data sheet before initiating or completing a design.

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